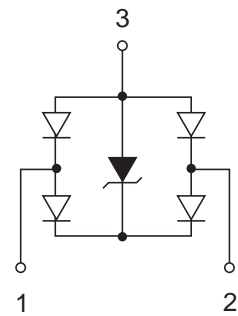
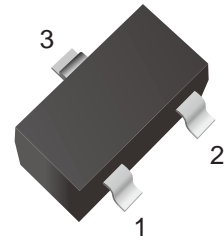


## Ultra Low Capacitance TVS/ESD Protection Diode

### Features

- Transient protection for high-speed data lines  
IEC 61000-4-2 (ESD) ±15kV (Air)  
±8kV (Contact)  
IEC 61000-4-4 (EFT) 40A (5/50 ns)  
Cable Discharge Event (CDE)
- Small package (1.6mm×0.8mm×0.75mm)
- Protects two data lines
- Low capacitance: 0.2pF Typical (I/O-I/O)
- Low leakage current
- Low clamping voltage
- Lead free in comply with EU RoHS 2011/65/EU directives



### Mechanical Data

- Case: SOT-523
- Flammability Rating: UL 94V-0
- MSL1
- Material: Halogen free

### Applications

- Serial ATA
- PCI Express
- MDDI Ports
- USB Data Line Protection
- HDMI Ports
- Digital Visual Interfaces (DVI)
- Desktops, Servers and Notebooks

### Ordering Information

Part Number	Marking	Shipping	Reel
LTE52A05L02LG-TR3	52L	3000PCS Tape&Reel	7 inches
LTE52A05L02LG-TR10	52L	10000PCS Tape&Reel	13 inches



### Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
$P_{PP}$	Peak Pulse Power (8/20 $\mu$ s)	60	W
$V_{ESD}$	ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	$\pm 20$ $\pm 20$	kV
$T_{OPT}$	Operating Temperature	-55/+125	$^{\circ}$ C
$T_{STG}$	Storage Temperature	-55/+125	$^{\circ}$ C

### Electrical Characteristics (T<sub>amb</sub>=25 $^{\circ}$ C)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
$V_{RWM}$	Reverse Working Voltage	I/O to GND			5.0	V
$V_{BR}$	Reverse Breakdown Voltage	$I_T = 1mA$ Between I/O and GND	6.0			V
$I_R$	Reverse Leakage Current	$V_{RWM} = 5V$ Between I/O and GND			100	nA
$V_F$	Forward Voltage	$I_T = 10mA$ Between I/O and GND			1.2	V
$V_C$	Clamping Voltage	$I_{PP} = 1A, t_p = 8/20\mu s$ Between I/O and GND			10	V
		$I_{PP} = 4A, t_p = 8/20\mu s$ Between I/O and GND			15	V
$C_T$	Total Capacitance	$V_R = 0V, f = 1MHz$ Between I/O and GND		0.4	0.6	pF
		$V_R = 0V, f = 1MHz$ Between I/O and I/O		0.2	0.3	pF



### Characteristics Curves

Fig.1 Power Derating Curve

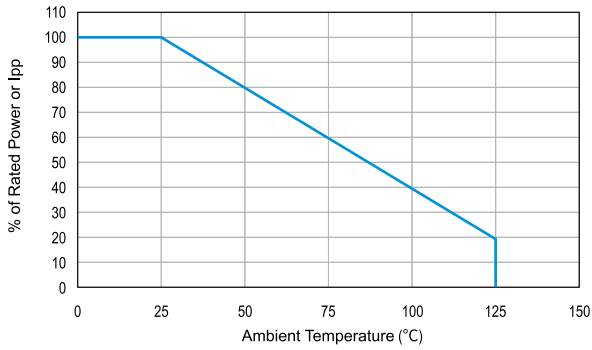


Fig.2 Clamping Voltage vs Peak Pulse Current

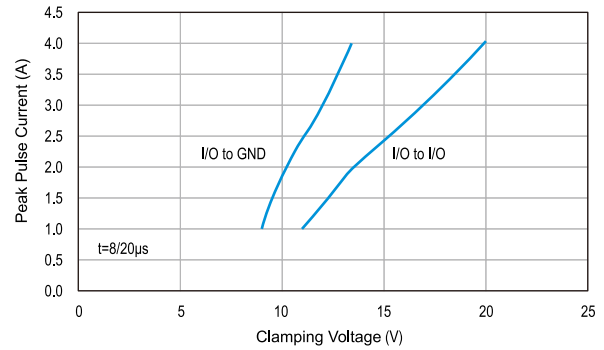


Fig.3 Voltage Sweeping of I/O to I/O

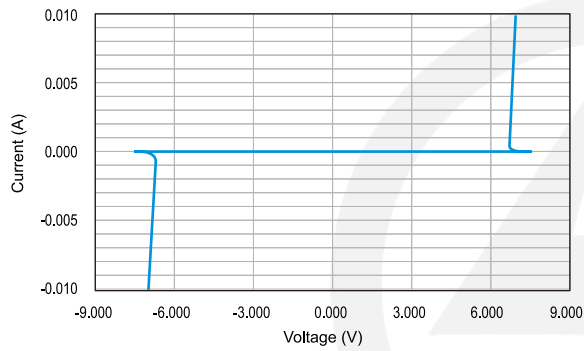


Fig.4 Voltage vs Capacitance

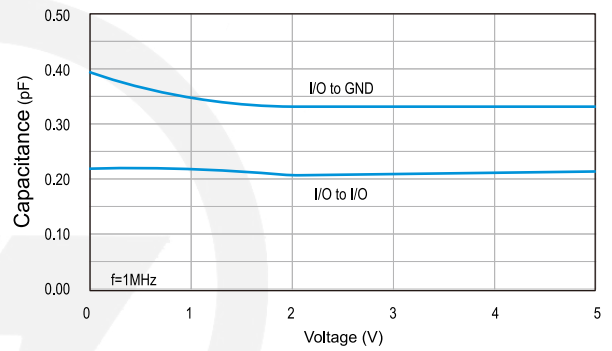


Fig.5 ESD Clamping of I/O to GND (+8kV Contact per IEC 61000-4-2)

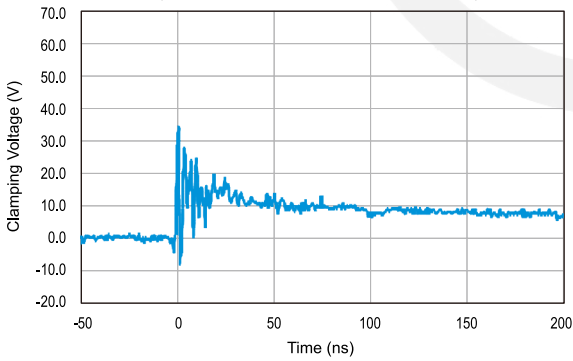
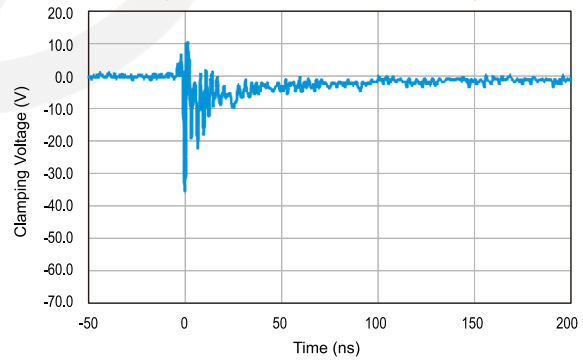
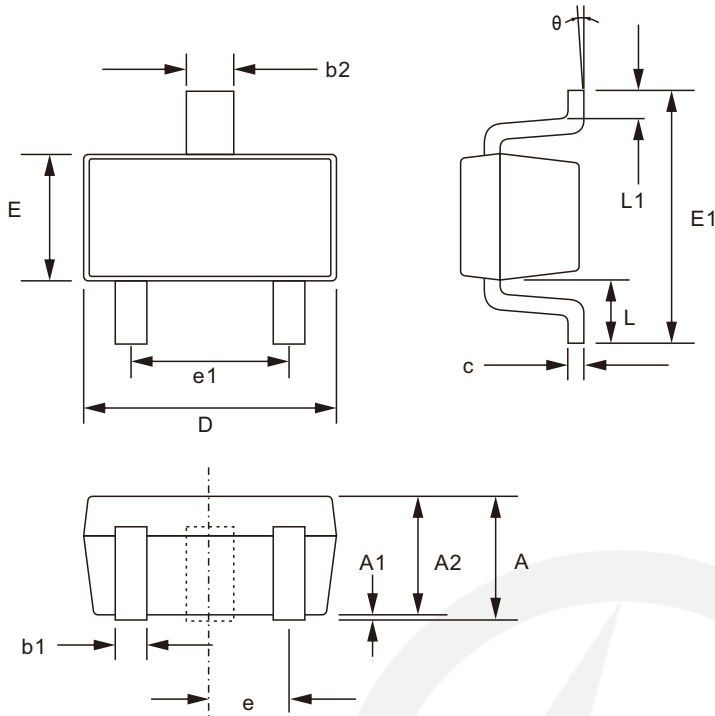


Fig.6 ESD Clamping of I/O to GND (-8kV Contact per IEC 61000-4-2)



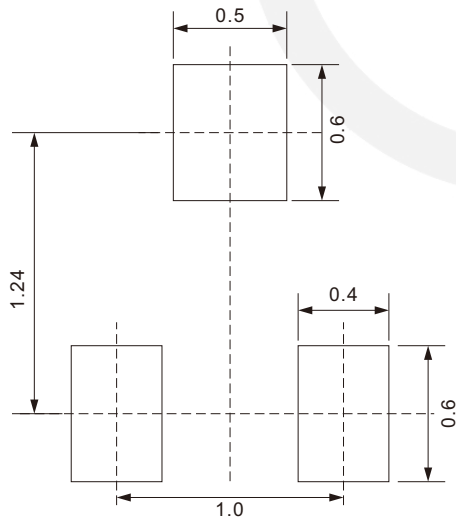
## SOT-523 Package Outline



Unit: mm

SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.70	0.90
A1	0.00	0.10
A2	0.70	0.80
b1	0.15	0.25
b2	0.25	0.35
c	0.10	0.20
D	1.50	1.70
E	0.70	0.90
E1	1.45	1.75
e	0.50 TYP.	
e1	0.90	1.10
L	0.40 TYP.	
L1	0.10	0.30
$\theta$	0°	8°

## SOT-523 Suggested Pad Layout

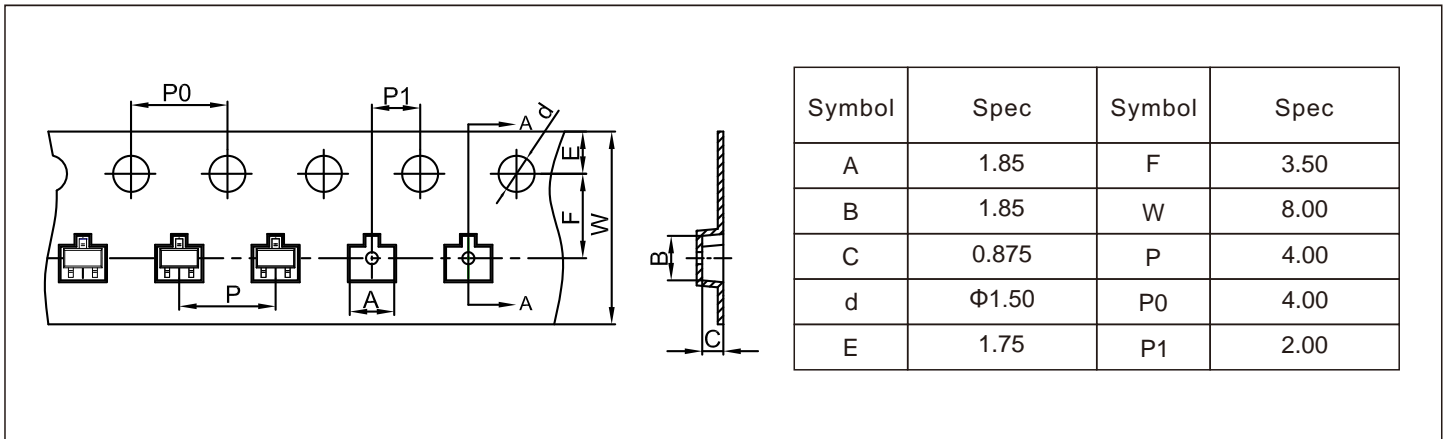


**Note:**

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

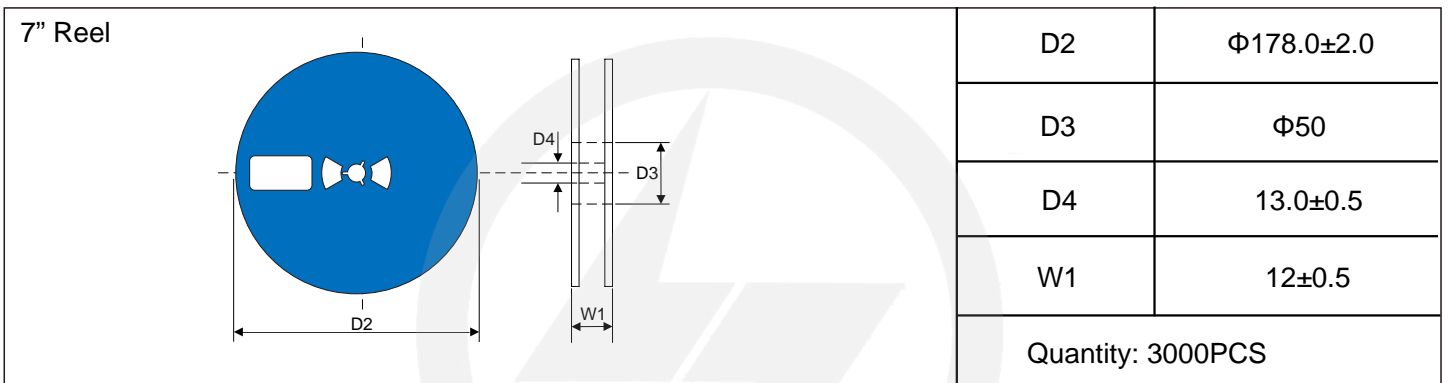
## Carrier Tape Dimensions

Unit : mm



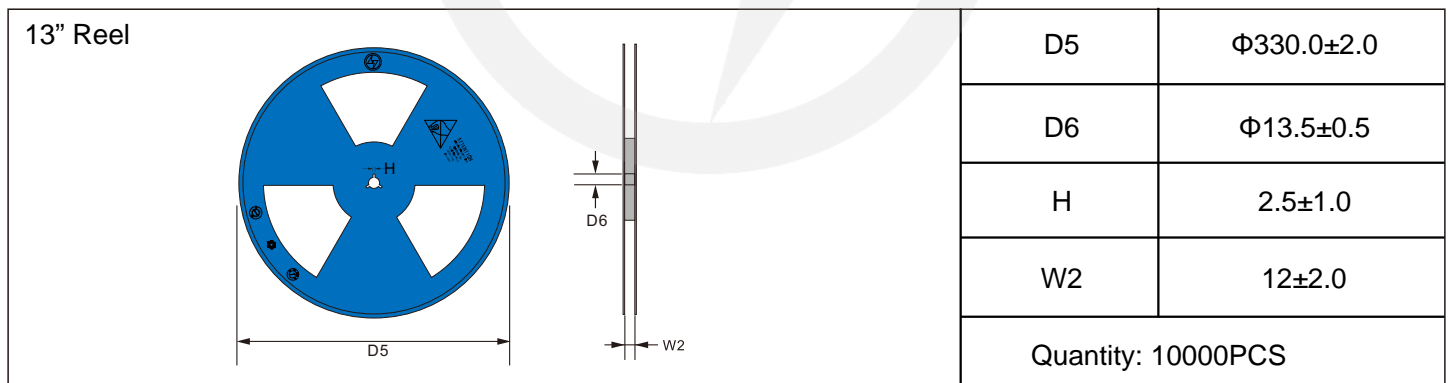
## Reel Dimensions

Unit : mm

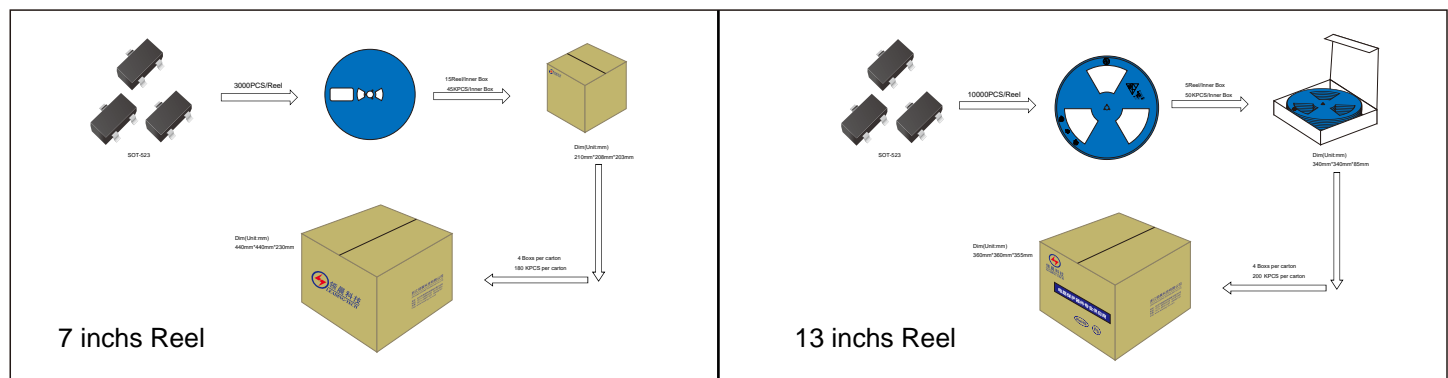


## Reel Dimensions

Unit : mm

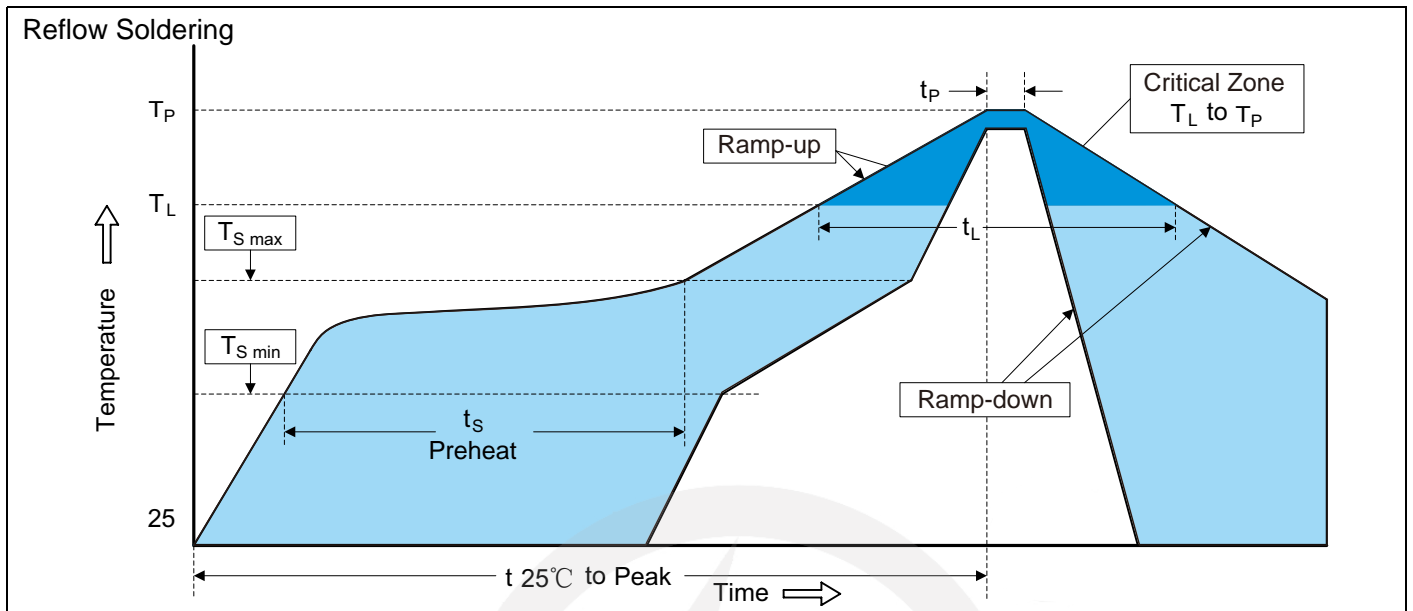


## Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.
Preheat	
-Temperature Min (T <sub>S min</sub> )	150°C
-Temperature Max (T <sub>S max</sub> )	200°C
-Time (min to max) (t <sub>s</sub> )	60-180 seconds
T <sub>S max</sub> to T <sub>L</sub>	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T <sub>L</sub> )	217°C
-Time (t <sub>L</sub> )	60-150 seconds
Peak Temperature (T <sub>P</sub> )	260°C
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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## Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.4.5	2024.4.5	3.0	New File	/	Ding	
02	2025.06.18	2025.06.18	3.1	Update packaging information	/	Ding	